

SLD80N03T

30V N -Channel MOSFET

General Description

This Power MOSFET is produced using Maplesemi's advanced TRENCH technology.

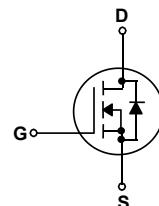
This advanced technology has been especially tailored to minimize conduction loss, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode.

Application

- PWM Application
- Load Switch
- Power Management

Features

- N-Channel:30V 80A
- $R_{DS(on)Typ} = 4.0m\Omega @ V_{GS} = 10\text{ V}$
- $R_{DS(on)Typ} = 7.0m\Omega @ V_{GS} = 4.5\text{V}$
- Very Low On-resistance RDS(ON)
- Low Crss
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability



Absolute Maximum Ratings

$T_c = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	SLD80N03T	Units
V_{DSS}	Drain-Source Voltage	30	V
I_D	Drain Current - Continuous ($T_c = 25^\circ\text{C}$)	80	A
	- Continuous ($T_c = 100^\circ\text{C}$)	45	A
I_{DM}	Drain Current - Pulsed	(Note 1)	A
V_{GSS}	Gate-Source Voltage	± 20	V
E_{AS}	Single Pulsed Avalanche Energy	(Note 2)	mJ
P_D	Power Dissipation ($T_c = 25^\circ\text{C}$)	83	W
$R_{\theta JC}$	Thermal Resistance, Junction to Case	1.5	$^\circ\text{C}/\text{W}$
T_J, T_{STG}	Operating and Storage Temperature Range	-55 to +150	$^\circ\text{C}$
T_L	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds	300	$^\circ\text{C}$

* Drain current limited by maximum junction temperature.

N-Channel Typical Characteristics

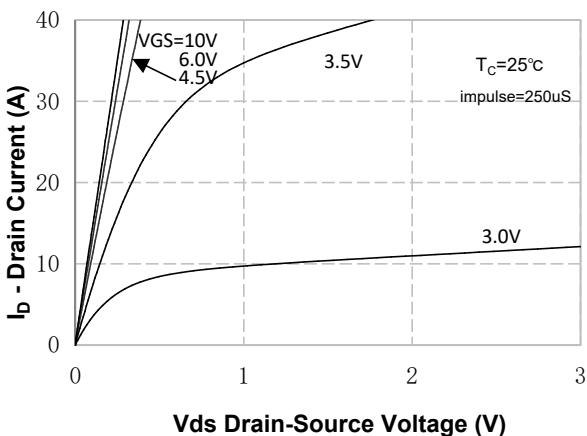


Figure 1. On-Region Characteristics

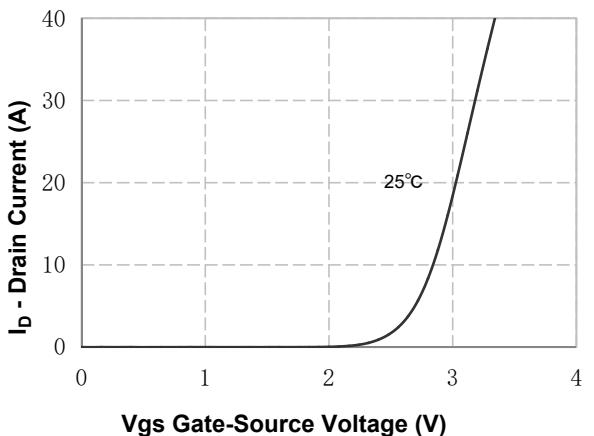


Figure 2. Transfer Characteristics

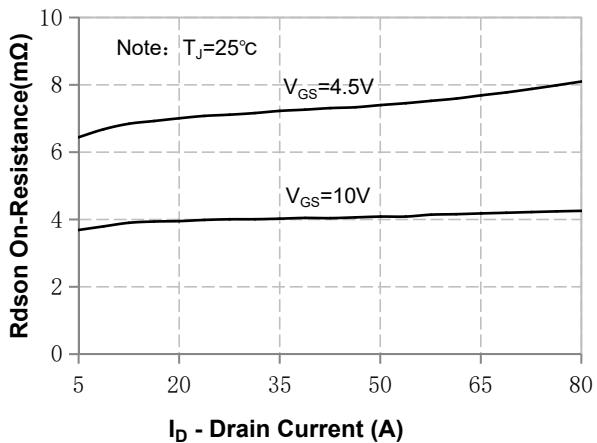


Figure 3. On-Resistance Variation vs Drain Current and Gate Voltage

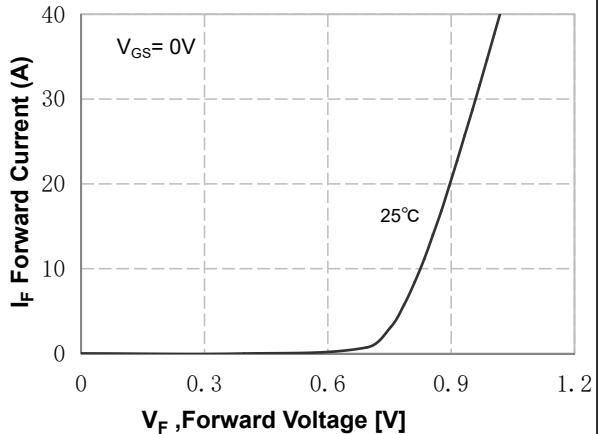


Figure 4. Body Diode Forward Voltage Variation vs Source Current

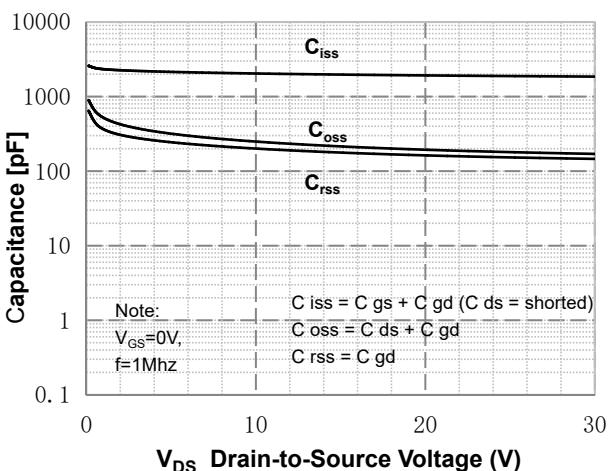


Figure 5. Capacitance Characteristics

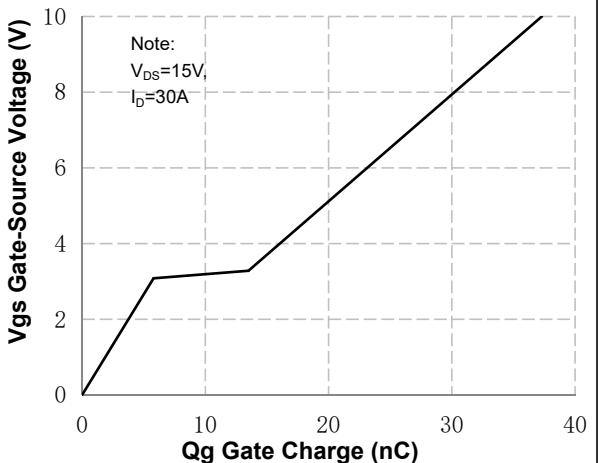
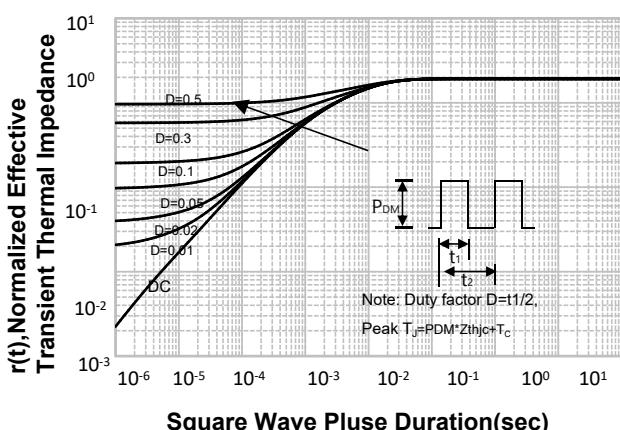
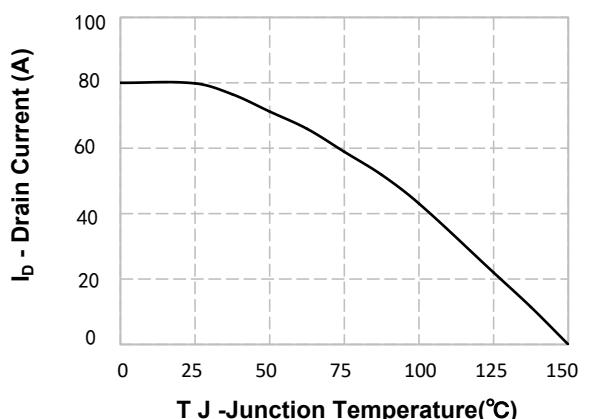
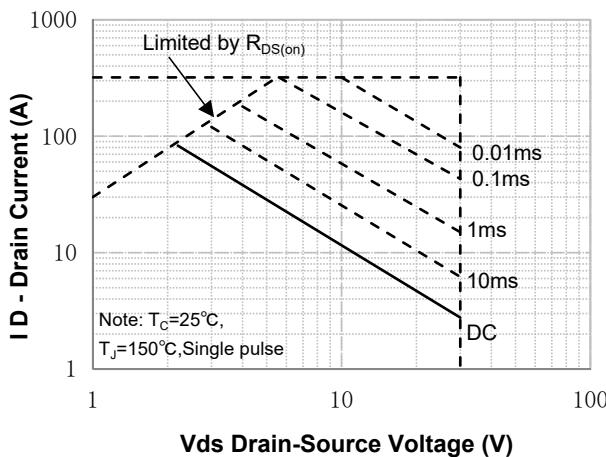
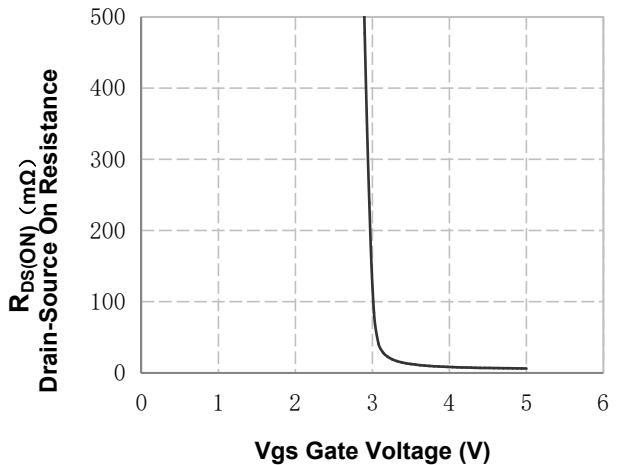
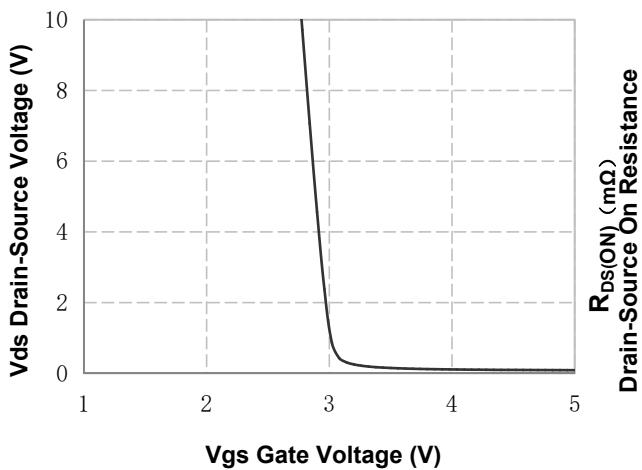
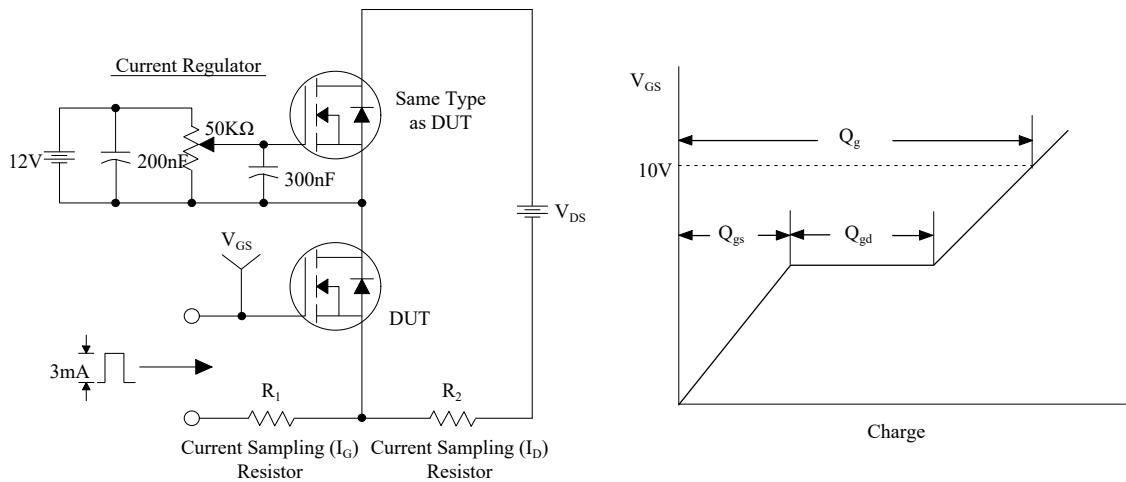


Figure 6. Gate Charge Characteristics

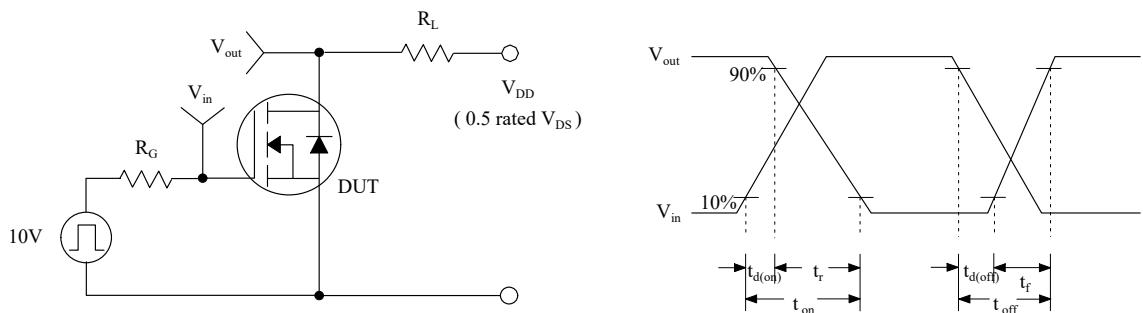
N-Channel Typical Characteristics (Continued)



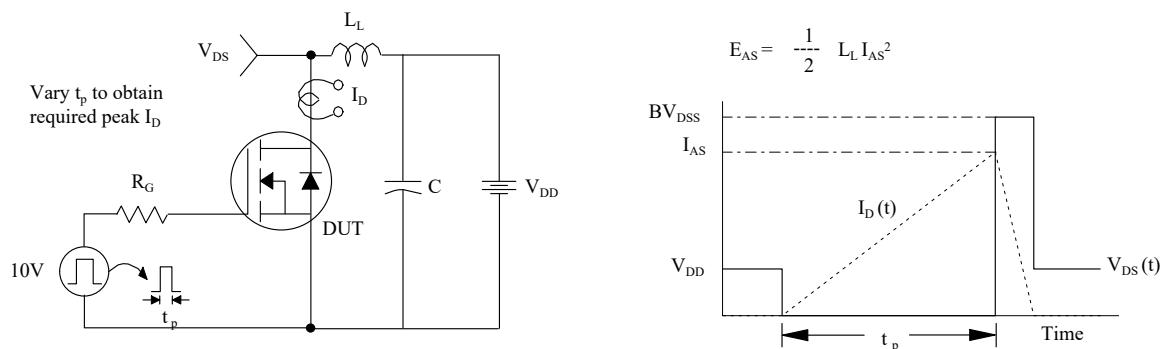
Gate Charge Test Circuit & Waveform



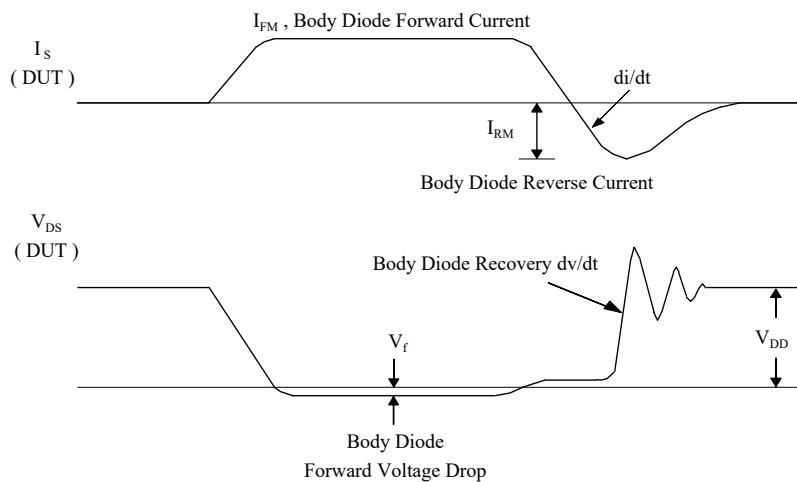
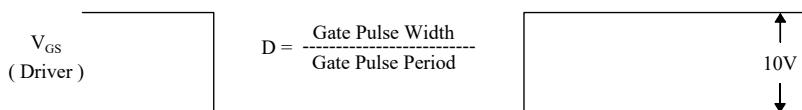
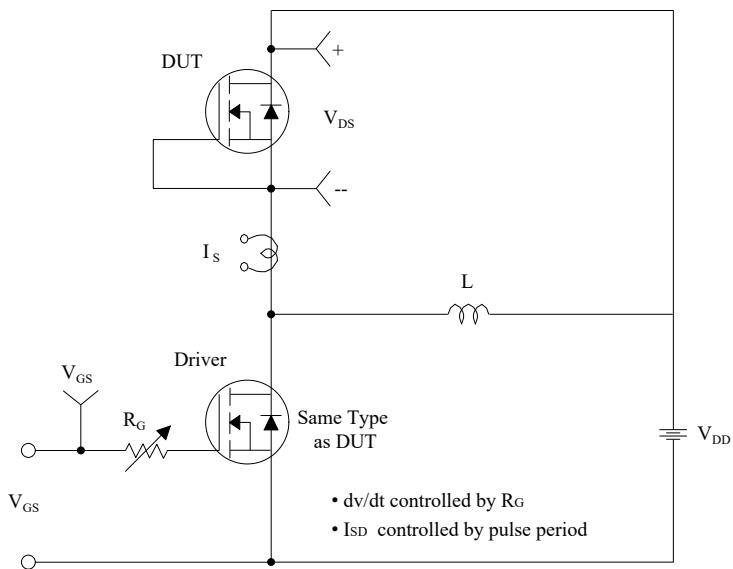
Resistive Switching Test Circuit & Waveforms



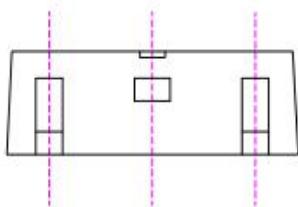
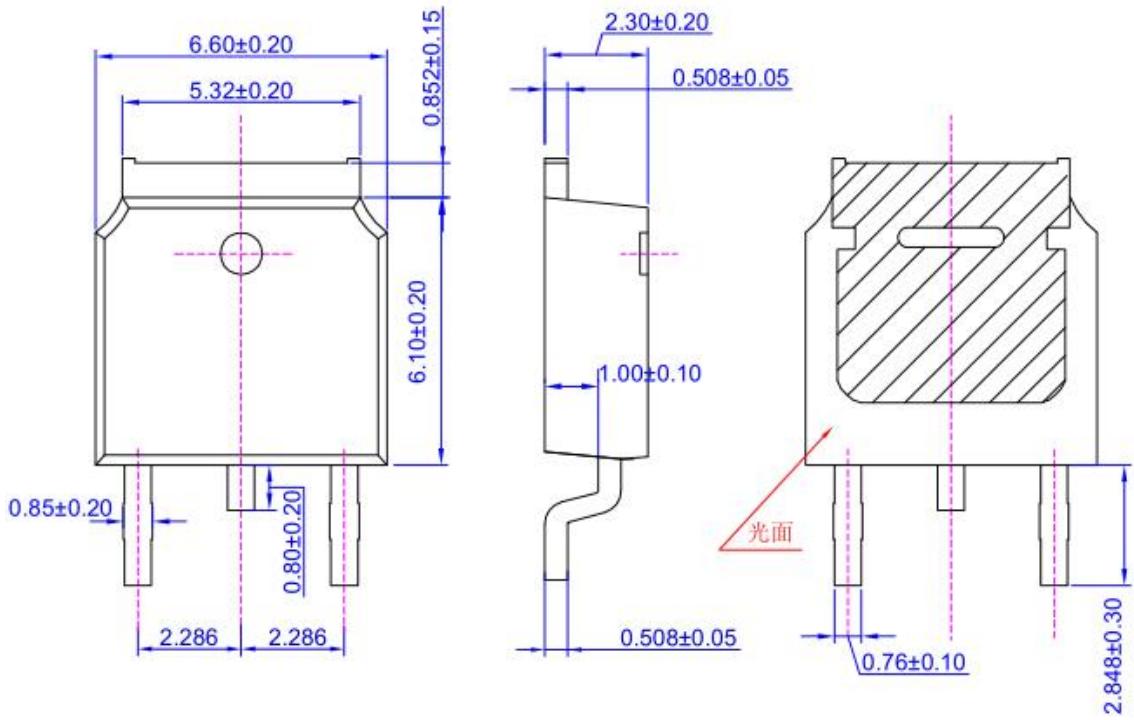
Unclamped Inductive Switching Test Circuit & Waveforms



Peak Diode Recovery dv/dt Test Circuit & Waveforms



TO-252 OUTLINE



NOTE:

- 1The plastic package is not marked as smooth surfaceRa=0.1;Subglossy surfaceRa=0.8
- 2.Undeclared tolerance ± 0.25 ,Unmarked filletRmax=0.25